IPC ASSOCIATION CON	Material Comp © Copyright 2005. I international and Pa	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both This do level pa	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Materi					ials and Mfc Information				
Supplier In							<u> </u>		,			<u> </u>			
Company name* Compan				ompany unique ID			Unique ID Authority					Response Date*			
nsemi												2025-06-02			
Contact Name	•		Title - Contact			Phone	Phone - Contact*					Email - Contact*			
Product-Env-	Stewards		Product Enviro Compliance			NA	NA				Product-Env-Stewards@onsemi.com				
uthorized Re	epresentative*		Title - Representative			Phone	Phone - Representative*				Email - Representative*				
Product-Env-	Stewards	Product Env	Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com					
Red	Requester Item Number		Mfr Item Number Mfr Item Name				ctive Date	Version	N	Manufacturing Site	1	Weight*	UOM	Unit Type	
		NCP4305DDR2G Secondary Driver for		Secondary Side Sy Driver for High Ef	nchronous Rectificatio ficiency SMPS Topolo			ГН2 71.91		1.91	mg	Each			
I anufactui	ring Proccess Informa	tion													
Terminal Plating / Grid Array Material Te			erminal Base Alloy J-STD-020 MSI		STD-020 MSL Rating	F	Peak Process Body Temperature Max		e Max Time at Peak	Temperat	ure Num	nber of Reflow Cyc	eles		
Matte Tin (Sn) - annealed		CU Alloy 3			2	260	0 C		30	secon	ds 3				
omments															
TTENTION:	: MSL 3 Rated item require	es Bake and D	ry Pack (afte	r electrical test)											
or more info	rmation regarding material	composition	please refer t	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale appl											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.33	mg	Supplier	Silicon (Si)	7440-21-3		1.33	mg
Die Attach	2.4	mg		Epoxy resin	proprietary data		0.312	mg
			Supplier	Silver (Ag)	7440-22-4		0.84	mg
			Supplier	Acrylic resins	Proprietary Data		0.408	mg
			Supplier	Aluminum (Al)	7429-90-5		0.84	mg
Lead Frame	37.61	mg	Supplier	Silver (Ag)	7440-22-4		0.1128	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0715	mg
			Supplier	Iron (Fe)	7439-89-6		0.9741	mg
			Supplier	Copper (Cu)	7440-50-8		36.399	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0527	mg
Mold Compound-Black	28.58	mg	Supplier	4,4'-Bis(2,3-epoxypropoxy)-3,3',5,5'-tetramethylbiphenyl	85954-11-6		1.2861	mg
			Supplier	Carbon Black (C)	1333-86-4		0.1429	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		26.2936	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.8574	mg
Plating	1.89	mg	Supplier	Tin (Sn)	7440-31-5		1.89	mg
Wire Bond	0.1	mg	Supplier	Palladium (Pd)	7440-05-3		0.0021	mg
			Supplier	Gold (Au)	7440-57-5		0.0003	mg
			Supplier	Copper (Cu)	7440-50-8		0.0976	mg